TE Internal #: 1-2324271-8

LGA 4189, 2097 Position, Surface Mount - Solder Ball, .9906 x .8585

mm [.039 x .0338 in] Grid, Board Mount, LGA Sockets

View on TE.com >



Connectors > Socket Connectors > IC Sockets > LGA Sockets



IC Socket Type: LGA 4189 Number of Positions: 2097

Contact Mating Area Plating Material Thickness: [15 µin] Termination Method to PCB: Surface Mount - Solder Ball

Grid Spacing: .9906 x .8585 mm [.039 x .0338 in]

Features

Product Type Features

| Connector & Contact Terminates To | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| Configuration Features | |

| Number of Positions | 2097 |
|---------------------|-----------------------------------|
| Grid Spacing | .9906 x .8585 mm[.039 x .0338 in] |

Body Features

| Frame Style | C Shape | |
|---------------------------------------|---------|--|
| · · · · · · · · · · · · · · · · · · · | | |

Contact Features

| Contact Mating Area Plating Material | Gold (Au) |
|--------------------------------------|--------------|
| Contact Base Material | Copper Alloy |
| IC Socket Type | LGA 4189 |
| | 15 μin |
| Contact Current Rating (Max) | .5 A |

Termination Features

| Termination Method to PCB Surface Mount - Solder Ball |
|-------------------------------------------------------|
|-------------------------------------------------------|

Mechanical Attachment

| Connector Mounting Type | Board Mount |
|-------------------------|-------------|
|-------------------------|-------------|

Housing Features



| Housing Material | High Temperature Thermoplastic |
|-----------------------------|--------------------------------|
| Housing Color | Black |
| Usage Conditions | |
| Operating Temperature Range | -25 – 100 °C[-13 – 212 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Tray Color | Black |
| Packaging Method | Tray |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|-----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer

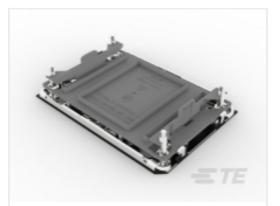
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



TE Part # 3-2330550-1 SOCKET P5 BOLSTER PLATE ASSY, W **/O COVER**

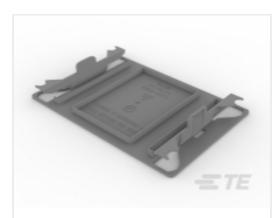


TE Part # 3-2330550-2 SOCKET P5 BOLSTER PLATE ASSY, W/ COVER



TE Part # 2-2330551-1 SOCKET P4/P5 BACKPLATE ASSY, STUD 6.02MM





TE Part # 2-2330553-1 SOCKET P4/P5 DUST COVER, LGA4189

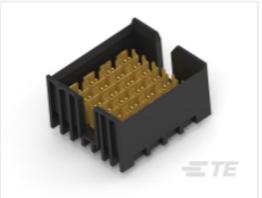


TE Part # 2-2330551-2 SOCKET P4/P5 BACKPLATE ASSY, STUD 7.12MM

Customers Also Bought



ASSY STR 168P 076 SLIVER 2.0W/O **SCREW**



SW HDR ASM, 4P, 6C, 85O, PIC



TE Part #2007882-3 IMP100S,H,V6P10C,UG,DEW46,5.5



TE Part #1-2324271-7 RIGHT SEGMENT LGA4189-5 SOCKETP5 FOR ODM



TE Part #1-1734774-2 PCI EXP 3.1L 98 POS BLK 15u"





TE Part #1735805-5 0.8FH,R13H.5,120,08/Sn,TR,WSC





TE Part #2356580-1 SOCKET P4 TFLM KIT W/O COVER



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2324271-8_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2324271-8_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2324271-8_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

LGA 4189 Socket and Hardware

English

1-1773982-5-lga_4189_flyer_cn

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English